TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

# 2SC5084

### VHF~UHF Band Low Noise Amplifier Applications

Low noise figure, high gain.

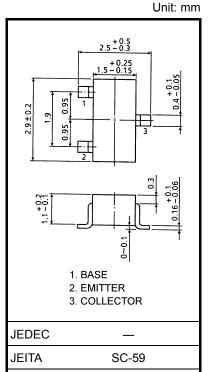
• NF = 1.1dB,  $|S_{21e}|^2 = 11dB$  (f = 1 GHz)

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	$V_{CBO}$	20	V	
Collector-emitter voltage	$V_{CEO}$	12	V	
Emitter-base voltage	$V_{EBO}$	3	V	
Base current	ΙΒ	40	mA	
Collector current	IC	80	mA	
Collector power dissipation	PC	150	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	<b>−55~125</b>	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



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Weight: 0.012 g (typ.)

**TOSHIBA** 

### **Microwave Characteristics (Ta = 25°C)**

Characteristics	Characteristics Symbol Test Condition		Min	Тур.	Max	Unit	
Transition frequency	f <sub>T</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA}$	5	7	_	GHz	
Insertion gain	S <sub>21e</sub>   <sup>2</sup> (1)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA, f = 500 MHz	_	16.5	_	dB	
insertion gain	S <sub>21e</sub>   <sup>2</sup> (2)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA, f = 1 GHz	GHz 7.5 11 —				
Noise figure	NF (1)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 5 mA, f = 500 MHz	_	1	_	dB	
Noise ligure	NF (2)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 5 mA, f = 1 GHz	_	1.1	2	] ub	

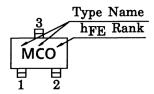
#### **Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0$	_	_	1	μА
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 1 V, I <sub>C</sub> = 0	_	_	1	μА
DC current gain	h <sub>FE</sub> (Note 1)	V <sub>CE</sub> = 10 V, I <sub>C</sub> = 20 mA	80	_	240	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>F</sub> = 0, f = 1 MHz (Note 2)	_	1.0	_	pF
Reverse transfer capacitance	C <sub>re</sub>	VCB = 10  V, 1E = 0, 1 = 1  MHz (Note 2)	_	0.65	1.15	pF

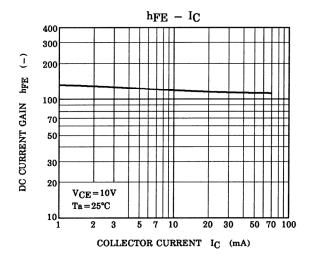
Note 1: hFE classification O: 80~160, Y: 120~240

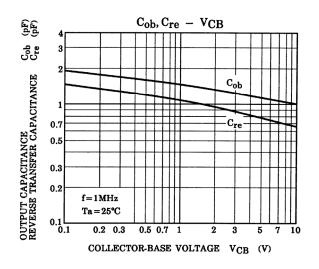
Note 2: C<sub>re</sub> is measured by 3 terminal method with capacitance bridge.

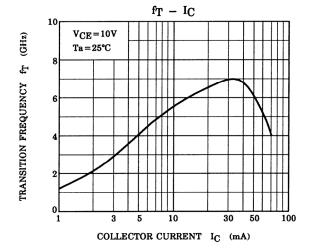
# Marking

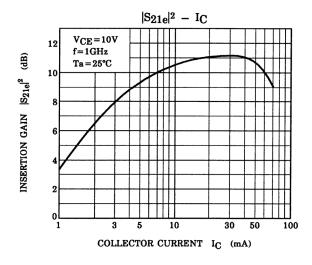


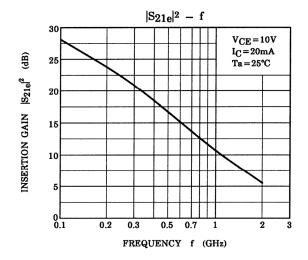
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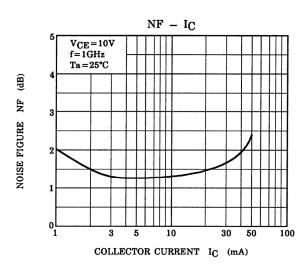




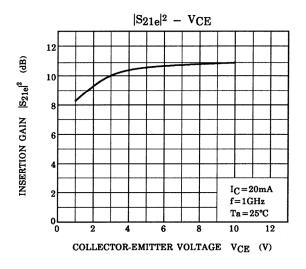


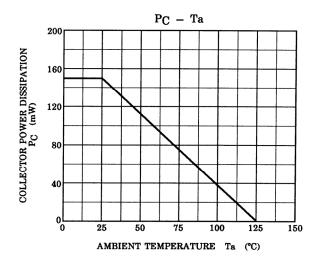






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# S-Parameter $Z_O = 50 \Omega$ , $Ta = 25^{\circ}C$

## $V_{CE} = 10 \text{ V}, I_C = 5 \text{ mA}$

Frequency	S	11	S	21	S	12	S	22
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.628	-77.1	9.254	126.5	0.051	53.3	0.695	-31.0
400	0.471	-122.1	6.027	103.3	0.067	48.4	0.509	-34.9
600	0.417	-149.1	4.341	90.3	0.077	51.9	0.441	-35.2
800	0.404	-167.3	3.381	81.2	0.090	56.9	0.412	-36.0
1000	0.402	178.1	2.798	73.3	0.104	62.0	0.398	-37.7
1200	0.412	166.6	2.393	66.7	0.122	66.4	0.390	-40.3
1400	0.427	156.6	2.108	60.4	0.145	69.1	0.385	-44.3
1600	0.440	147.3	1.881	54.8	0.170	69.8	0.376	-48.8
1800	0.455	140.0	1.713	49.4	0.194	70.2	0.373	-54.3
2000	0.482	132.6	1.586	44.6	0.223	71.3	0.367	-60.0

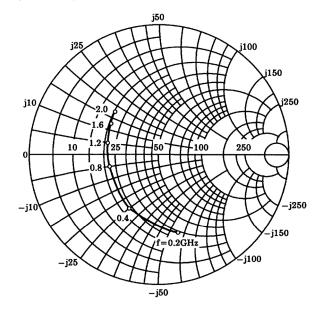
## $V_{CE} = 10 \text{ V}, I_C = 20 \text{ mA}$

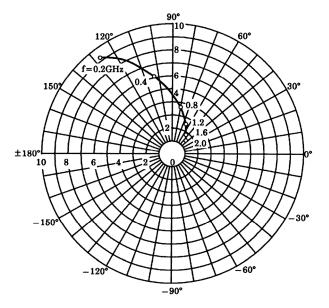
Frequency	S11		S21		S12		S22	
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.340	-122.7	15.443	107.4	0.034	62.7	0.415	-40.5
400	0.299	-158.7	8.266	92.4	0.056	69.3	0.293	-34.2
600	0.293	-178.0	5.664	84.0	0.080	71.7	0.265	-30.4
800	0.294	169.0	4.334	77.3	0.104	72.1	0.255	-29.9
1000	0.299	157.9	3.528	71.2	0.129	72.0	0.252	-30.6
1200	0.310	149.5	3.002	66.0	0.155	71.4	0.254	-32.5
1400	0.321	142.0	2.629	61.0	0.183	69.7	0.255	-36.1
1600	0.332	134.9	2.336	56.3	0.209	67.6	0.248	-40.6
1800	0.341	129.5	2.121	51.7	0.234	65.6	0.242	-45.9
2000	0.366	124.3	1.958	47.3	0.260	64.6	0.236	-51.7

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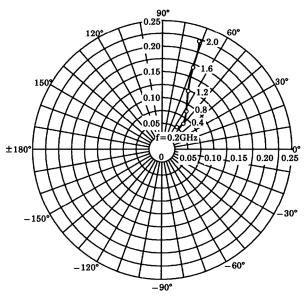
 $\begin{array}{l} S_{11e} \\ V_{CE} = 10V \\ I_{C} = 5mA \\ Ta = 25^{\circ}C \\ (UNIT:\Omega) \end{array}$ 







 $\begin{array}{l} S_{12e} \\ V_{CE} = 10V \\ I_{C} = 5 \text{mA} \\ Ta = 25 ^{\circ}\text{C} \end{array}$ 

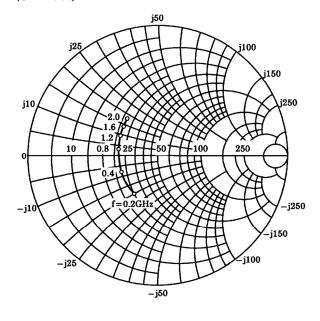


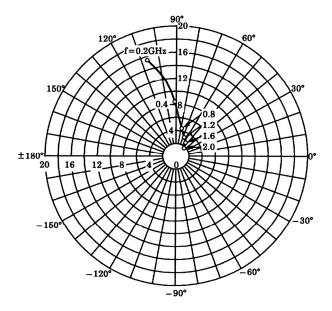
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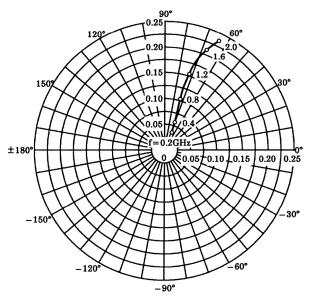
 $\begin{array}{l} S_{11e} \\ V_{CE} = 10V \\ I_{C} = 20 mA \\ Ta = 25 ^{\circ}C \\ (UNIT: \Omega) \end{array}$ 



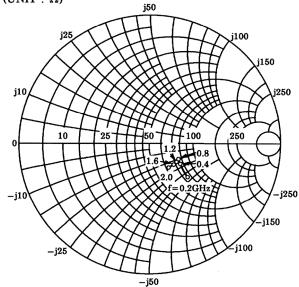




 $\begin{array}{l} \mathrm{S}_{12e} \\ \mathrm{V}_{CE} \!=\! 10\mathrm{V} \\ \mathrm{I}_{C} \!=\! 20\mathrm{mA} \\ \mathrm{Ta} \!=\! 25^{\circ}\!\mathrm{C} \end{array}$ 



 $\begin{array}{l} S_{22e} \\ V_{CE} = 10V \\ I_{C} = 20 mA \\ T_{a} = 25 ^{\circ}C \\ (UNIT: \Omega) \end{array}$ 



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20070701-EN GENERAL

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